

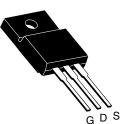
**Vishay Siliconix** 

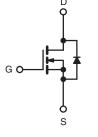


## **E Series Power MOSFET**

PRODUCT SUMMARY				
$V_{DS}$ (V) at $T_{J}$ max.	650			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.125		
Q <sub>g</sub> max. (nC)	130			
Q <sub>gs</sub> (nC)	15			
Q <sub>gd</sub> (nC)	39			
Configuration	Sing	le		

### TO-220 FULLPAK





N-Channel MOSFET

### **FEATURES**

- Low Figure-of-Merit (FOM) Ron x Qa
- Low Input Capacitance (C<sub>iss</sub>)
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Q<sub>q</sub>)
- Avalanche Energy Rated (UIS)
- Compliant to RoHS Directive 2002/95/EC

### **APPLICATIONS**

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
  - High-Intensity Discharge (HID)
  - Fluorescent Ballast Lighting
  - LED Lighting
- Industrial
  - Welding
  - Induction Heating
  - Motor Drives
- Battery Chargers
- Renewable Energy
  - Solar (PV Inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF30N60E-E3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	600		
Gate-Source Voltage				± 20	V	
Gate-Source Voltage AC (f > 1 Hz)			V <sub>GS</sub> –	30		
Continuous Durin Current /T 150 °C)d	V <sub>GS</sub> at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	1	29	А	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>d</sup>	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	18		
Pulsed Drain Current <sup>a</sup>	n Current <sup>a</sup>		I <sub>DM</sub>	65		
Linear Derating Factor				2	W/°C	
Avalanche Energy (repetitive)			E <sub>AR</sub>	0.25	mJ	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	690		
Maximum Power Dissipation			PD	37	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Drain-Source Voltage Slope T <sub>J</sub> = 125 °C		dV/dt	37	1//20		
Reverse Diode dV/dt <sup>e</sup>			18	V/ns		
Soldering Recommendations (Peak Temperature)	for	10 s		300 <sup>c</sup>	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 7 A.

c. 1.6 mm from case.

d. Limited by maximum junction temperature.

e.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C.

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COMPLIANT



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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		65				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		3.4		- °C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherwi	ise noted)						
PARAMETER	SYMBOL	-		ONS	MIN.	TYP.	MAX.	UNIT
Static					L			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		600	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub>	= 250 μA	-	0.64	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	50 µA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero Gate Voltage Drain Current			$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	
	I <sub>DSS</sub>	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$		-	-	100	μA	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		= 15 A	-	0.104	0.125	Ω
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>D</sub>	<sub>s</sub> = 8 V, I <sub>D</sub> =	3 A	-	5.4	-	S
Dynamic			-				1	<u> </u>
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	2600	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 100 V$		-	138	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1.0 MHz	1	-	3	-	
Total Gate Charge	Qg				-	85	130	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 15 A	, V <sub>DS</sub> = 480 V	-	15	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	39	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	19	40	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 380 V, I <sub>D</sub> = 15 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω		-	32	65	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	63	95		
Fall Time	t <sub>f</sub>			-	36	75		
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.63	-	Ω	
Drain-Source Body Diode Characteristic						-		
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the	MOSFET symbol showing the		-	-	29	•
Pulsed Diode Forward Current	I <sub>SM</sub>	integral revers p - n junction			-	-	65	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °0	C, I <sub>S</sub> = 15 A,	$V_{GS} = 0 V$	-	-	1.3	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>				-	402	605	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>		5 °C, I <sub>F</sub> = I <sub>S</sub>		-	7	15	μC
Reverse Recovery Current	I <sub>RRM</sub>	ai/at =	100 A/µs, V	<sub>R</sub> = ∠∪ v	_	32	65	A

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# SiHF30N60E

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### **TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

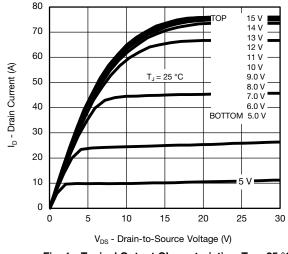
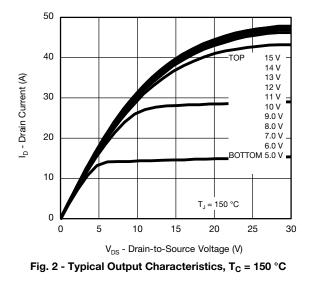


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C



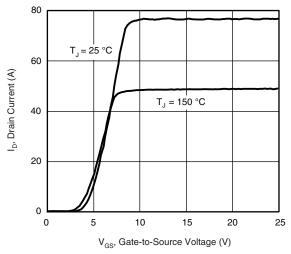
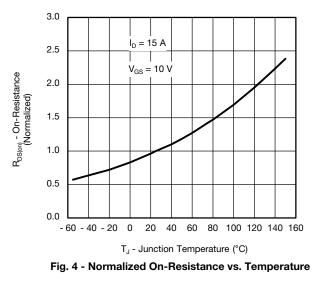


Fig. 3 - Typical Transfer Characteristics

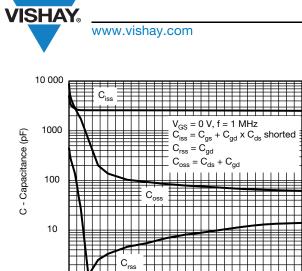


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## SiHF30N60E





200

1

0

100

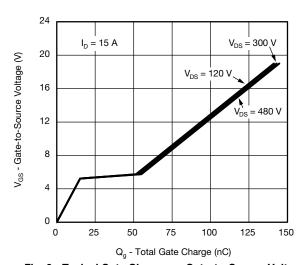
300 V<sub>DS</sub> - Drain-to-Source Voltage (V)

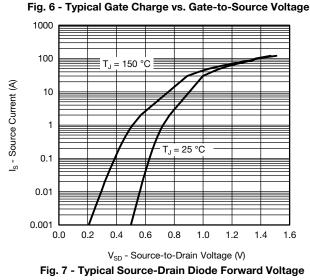
400

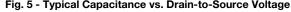
500

600









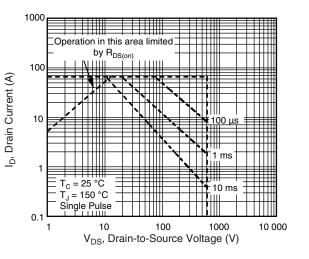
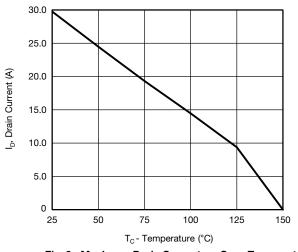
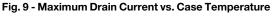
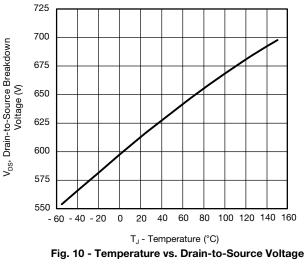


Fig. 8 - Maximum Safe Operating Area



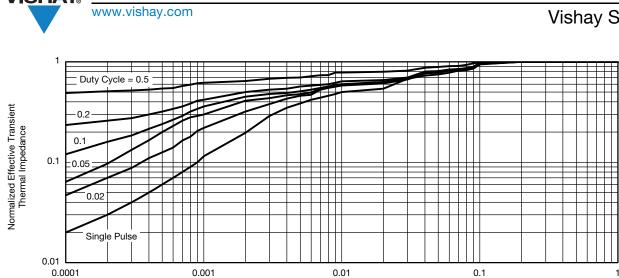




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Square Wave Pulse Duration (s)

Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

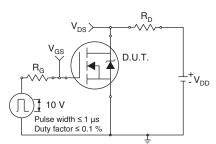


Fig. 12 - Switching Time Test Circuit

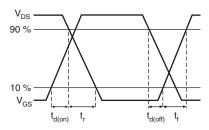


Fig. 13 - Switching Time Waveforms

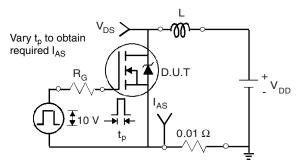


Fig. 14 - Unclamped Inductive Test Circuit

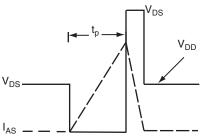


Fig. 15 - Unclamped Inductive Waveforms

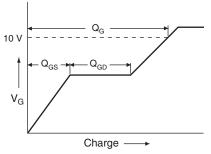


Fig. 16 - Basic Gate Charge Waveform

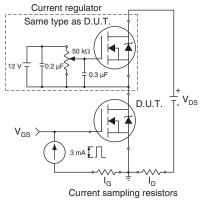


Fig. 17 - Gate Charge Test Circuit

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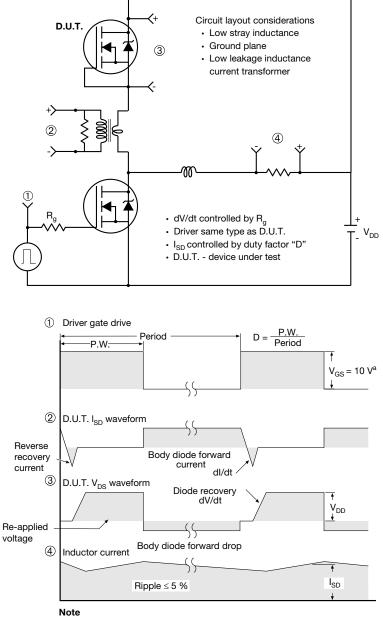
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### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

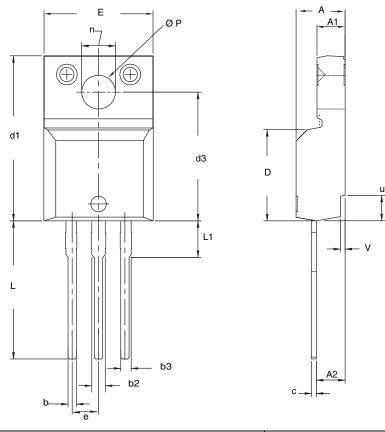
Fig. 18 - For N-Channel

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**Package Information** 

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## **TO-220 FULLPAK (HIGH VOLTAGE)**



	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØР	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet  $C_{pk} > 1.33$ .

4. All dimensions include burrs and plating thickness.

5. No chipping or package damage.



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